

# SN74CBT16390

## 16-BIT TO 32-BIT FET MULTIPLEXER/DEMULTIPLEXER BUS SWITCH

SCDS035D – OCTOBER 1997 – REVISED MAY 2000

- 5-Ω Switch Connection Between Two Ports
- TTL-Compatible Input Levels
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV), and Shrink Small-Outline (DL) Packages

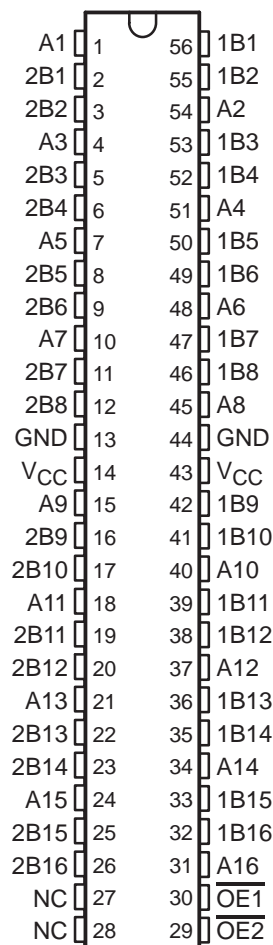
### description

The SN74CBT16390 is a 16-bit to 32-bit switch used in applications in which two separate data paths must be multiplexed onto, or demultiplexed from, a single path. This device can be used for memory interleaving, in which two different banks of memory must be addressed simultaneously. This device also can be used to connect or isolate the PCI bus to one or two slots simultaneously.

Two output enables ( $\overline{OE1}$  and  $\overline{OE2}$ ) control the data flow. When  $\overline{OE1}$  is low, A port is connected to 1B port. When  $\overline{OE2}$  is low, A port is connected to 2B port. When both  $\overline{OE1}$  and  $\overline{OE2}$  are low, the A port is connected to both 1B and 2B ports. The control inputs can be driven with a 5-V CMOS, 5-V TTL, or an LVTTTL driver.

The SN74CBT16390 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

### DGG, DGV, OR DL PACKAGE (TOP VIEW)



NC – No internal connection

### FUNCTION TABLE

INPUTS		FUNCTION
$\overline{OE1}$	$\overline{OE2}$	
L	L	A = 1B and A = 2B
L	H	A = 1B
H	L	A = 2B
H	H	Isolation



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### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT	
$V_{IK}$		$V_{CC} = 4.5\text{ V}$ ,	$I_I = -18\text{ mA}$			-1.2	V	
$I_I$		$V_{CC} = 0$ ,	$V_I = 5.5\text{ V}$			10	$\mu\text{A}$	
		$V_{CC} = 5.5\text{ V}$ ,	$V_I = 5.5\text{ V or GND}$			$\pm 1$		
$I_{CC}$		$V_{CC} = 5.5\text{ V}$ ,	$I_O = 0$ ,			3	$\mu\text{A}$	
$\Delta I_{CC}^\ddagger$	Control inputs	$V_{CC} = 5.5\text{ V}$ ,	One input at 3.4 V,	Other input at $V_{CC}$ or GND		2.5	mA	
$C_i$	Control inputs	$V_I = 3\text{ V or 0}$				5	pF	
$C_{iO}(\text{OFF})$		$V_O = 3\text{ V or 0}$				5.5	pF	
$r_{on}^\S$		$V_{CC} = 4.5\text{ V}$	$V_I = 0$	$I_I = 64\text{ mA}$		5	7	$\Omega$
				$I_I = 30\text{ mA}$		5	7	
			$V_I = 2.4\text{ V}$ ,	$I_I = 15\text{ mA}$		7	12	

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

§ Measured by the voltage drop between A and B terminals at the indicated current through the switch. On-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

### switching characteristics over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	MAX	UNIT
$t_{pd}^{\parallel}$	A or B	B or A		0.25	ns
$t_{en}$	$\overline{OE}$	A or B	1.3	5.9	ns
$t_{dis}$	$\overline{OE}$	A or B	1	5.3	ns

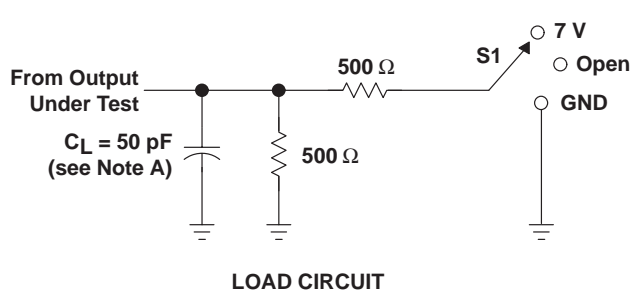
$\parallel$  The propagation delay is based on the RC time constant of the typical on-state resistance of the switch and a load capacitance of 50 pF, when driven by an ideal voltage source (zero output impedance).

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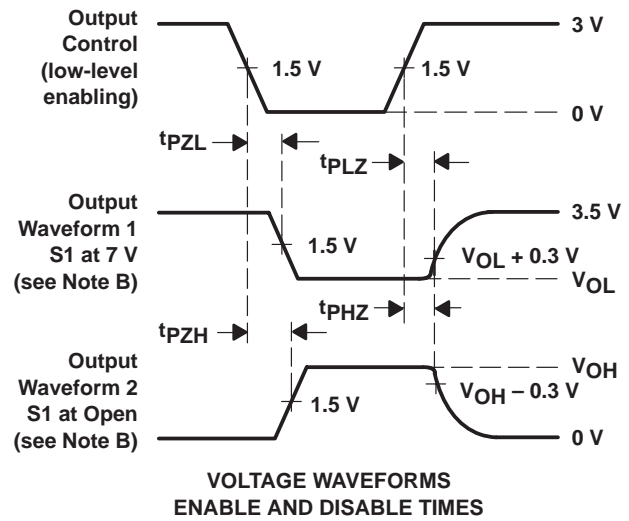
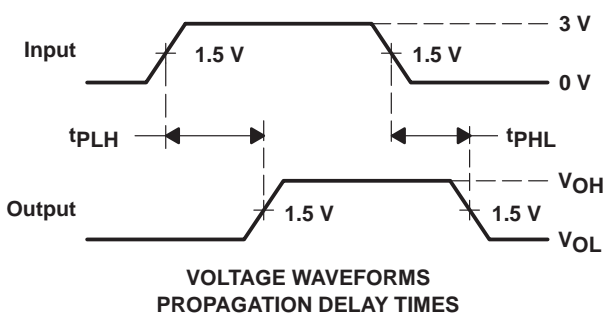
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### PARAMETER MEASUREMENT INFORMATION



TEST	S1
$t_{pd}$	Open
$t_{PLZ}/t_{PZL}$	7 V
$t_{PHZ}/t_{PZH}$	Open



- NOTES:
- A.  $C_L$  includes probe and jig capacitance.
  - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
  - D. The outputs are measured one at a time with one transition per measurement.
  - E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

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